

Product Summary

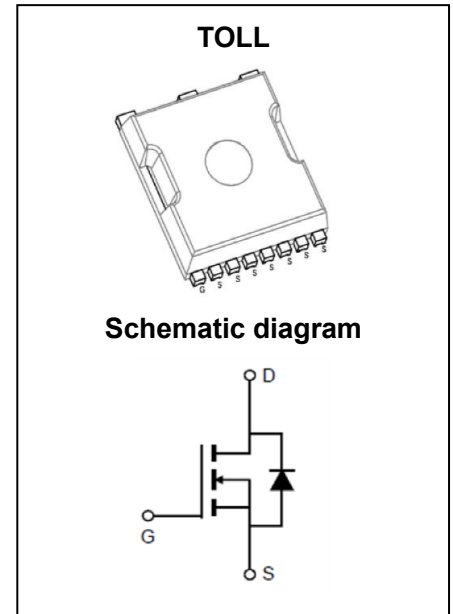
$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
60V	1.3m Ω @10V	300A

Feature

- Split Gate Trench Technology
- Low $R_{DS(ON)}$
- Low Gate Charge
- Low Gate Resistance
- 100% UIS Tested

Application

- Power Management
- Load Switching



Package Marking and Ordering Information

Part Number	Package	Marking	Packing	Reel Size	Tape Width	Qty
GPT016N06NTP	TOLL	T016N06N	Reel & Tape	330mm	24mm	2000pcs

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ¹	I_D	$T_C = 25^\circ\text{C}$	300
		$T_C = 100^\circ\text{C}$	190
Pulsed Drain Current ²	I_{DM}	1200	A
Single Pulsed Avalanche Current ³	I_{AS}	63	A
Single Pulsed Avalanche Energy ³	E_{AS}	992	mJ
Power Dissipation ⁵	P_D	312	W
Thermal Resistance from Junction to Ambient ⁶	$R_{\theta JA}$	30	$^\circ\text{C/W}$
Thermal Resistance from Junction to Case	$R_{\theta JC}$	0.4	$^\circ\text{C/W}$
Junction Temperature	T_J	150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55~ +150	$^\circ\text{C}$

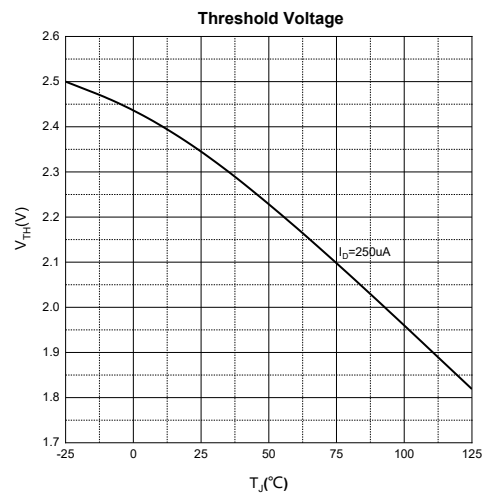
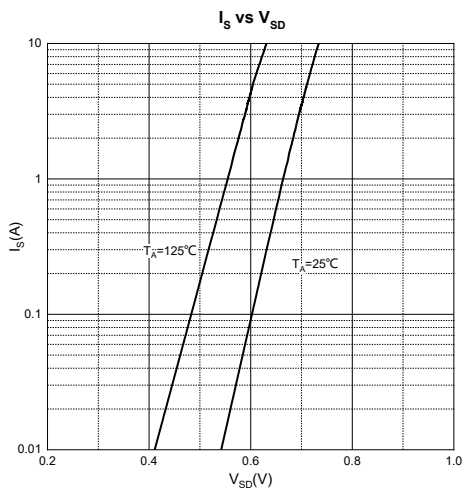
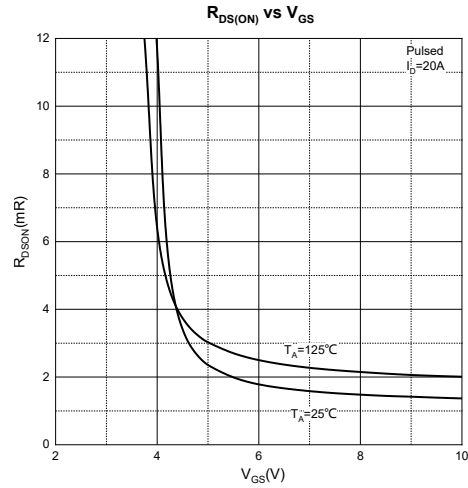
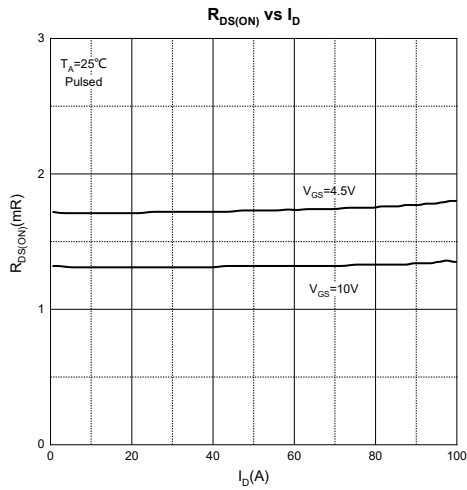
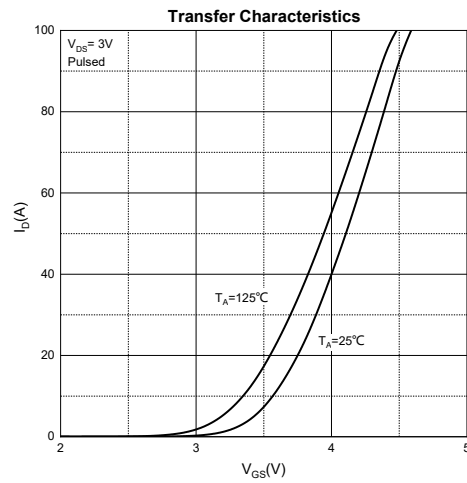
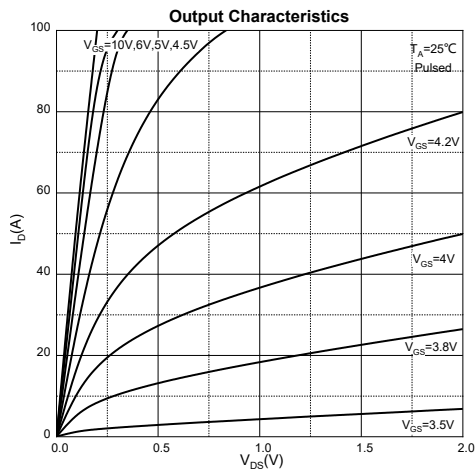
MOSFET ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

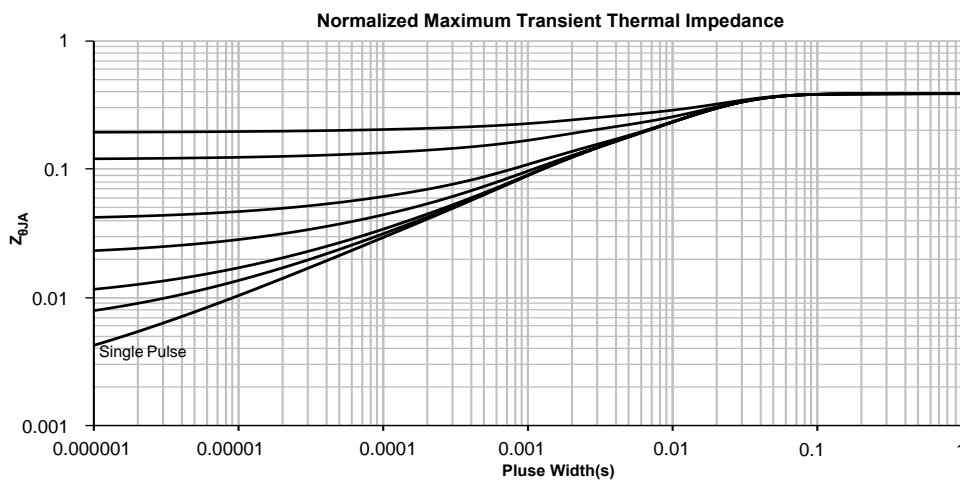
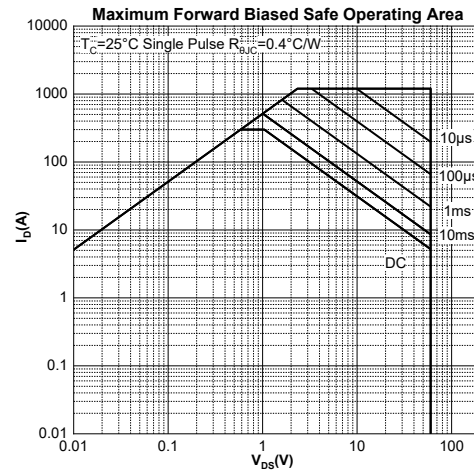
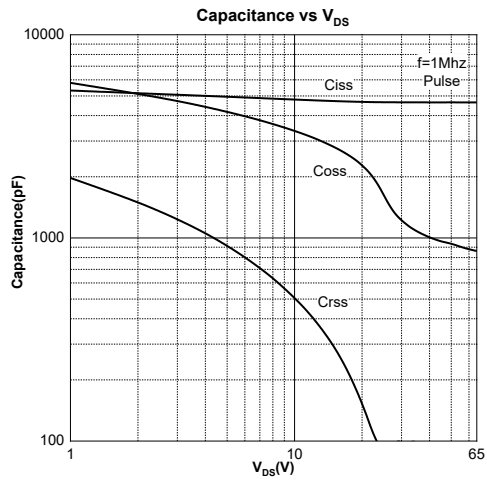
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	60			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60V, V _{GS} = 0V			1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V			±100	nA
On Characteristics⁴						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1.5	2.3	3.5	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 20A		1.3	1.7	mΩ
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} = 30V, V _{GS} = 0V, f = 1MHz		4528		pF
Output Capacitance	C _{oss}			1220		
Reverse Transfer Capacitance	C _{rss}			76		
Gate Resistance	R _g	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz		2.7		Ω
Switching Characteristics						
Total Gate Charge	Q _g	V _{DS} = 35V, V _{GS} = 10V, I _D = 20A		88		nC
Gate-Source Charge	Q _{gs}			16		
Gate-Drain Charge	Q _{gd}			26		
Gate Plateau Voltage	V _{plateau}			3.7		V
Turn-On Delay Time	t _{d(on)}	V _{DD} = 30V, V _{GS} = 10V, R _G = 2.2Ω, I _D = 150A		27		ns
Turn-On Rise Time	t _r			261		
Turn-Off Delay Time	t _{d(off)}			48		
Turn-Off Fall Time	t _f			13		
Source-Drain Diode Characteristics						
Diode Forward Voltage ⁴	V _{SD}	V _{GS} = 0V, I _S = 10A			1.2	V
Diode Continuous Forward Current ¹	I _S	T _C = 25°C			300	A
Diode Pulse Forward Current ²	I _{SM}				1200	A
Diode Reverse Recovery Time	t _{rr}	I _F = 150A, di/dt = 100A/μs		80		ns
Diode Reverse Recovery Charge	Q _{rr}				208	

Notes:

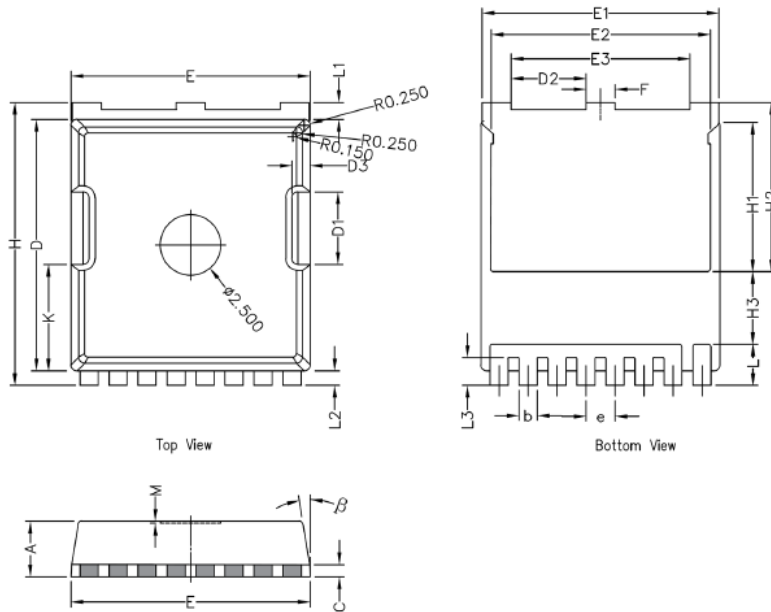
- The maximum current rating is limited by package. And device mounted on a large heatsink.
- Pulse Test: Pulse Width ≤ 10μs, duty cycle ≤ 1%.
- E_{AS} condition: V_{DD} = 40V, V_{GS} = 10V, L = 0.5mH, R_G = 25Ω Starting T_J = 25°C.
- Pulse Test: Pulse Width ≤ 300μs, duty cycle ≤ 2%.
- The power dissipation P_D is limited by T_{J(MAX)} = 150°C. And device mounted on a large heatsink.
- Device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A = 25°C.

Typical Characteristics





TOLL Package Information



SYMBOL	MILLIMETER		Dimensions In Inches	
	MIN.	MAX.	Min.	Max.
A	2.200	2.400	0.087	0.094
b	0.650	0.850	0.026	0.033
C	0.508REF		0.020 REF	
D	10.250	10.550	0.404	0.415
D1	2.850	3.150	0.112	0.124
D2	2.950	3.250	0.116	0.128
D3	0.750 REF		0.030 REF	
E	9.750	10.050	0.384	0.396
E1	9.650	9.950	0.380	0.392
E2	8.950	9.250	0.352	0.364
E3	7.250	7.550	0.285	0.297
e	1.200BSC		0.047 BSC	
F	1.050	1.350	0.041	0.053
H	11.550	11.850	0.455	0.467
H1	6.030	6.330	0.237	0.249
H2	6.850	7.150	0.270	0.281
H3	3.000 BSC		0.118 BSC	
L	1.550	1.850	0.061	0.073
L1	0.550	0.850	0.022	0.033
L2	0.450	0.750	0.018	0.030
L3	1.000	1.300	0.039	0.051
M	0.080 REF		0.003 REF	
β	8°	12°	8°	12°
K	4.250	4.550	0.167	0.179

Attention:

- GreenPower Electronics reserves the right to improve product design function and reliability without notice.
- Any and all semiconductor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.
- GreenPower Electronics products belong to consumer electronics or other civilian electronic products.